

Vishay High Power Products

FlipKY[®], 1.5 A Chip Scale Package Schottky Barrier Rectifier



FlipKY[®]

PRODUCT SUMMARY				
I _{F(AV)}	1.5 A			
V_{R}	40 V			

FEATURES

- Ultra low V_F per footprint area
- · Low leakage
- · Low thermal resistance
- · One-fifth footprint of SMA
- Super low profile (0.6 mm)
- · Available tested on tape and reel

APPLICATIONS

- · Reverse polarity protection
- · Current steering
- · Freewheeling
- Flyback
- Oring

DESCRIPTION

Vishay's FlipKY® product family utilizes wafer level chip scale packaging to deliver Schottky diodes with the lowest V_{F} to PCB footprint area in industry. The four bump 1.5 x 1.5 mm devices can deliver up to 1.5 A and occupy only 2.3 mm² of board space. The anode and cathode connections are made through solder bump pads on one side of the silicon enabling designers to strategically place the diodes on the PCB. This design not only minimizes board space but also reduces thermal resistance and inductance, which can improve overall circuit efficiency.

Typical applications include hand-held, portable equipment such as cell phones, MP3 players, bluetooth, GPS, PDAs, and portable hard disk drives where space savings and performance are crucial.

MAJOR RATINGS AND CHARACTERISTICS				
SYMBOL	CHARACTERISTICS	MAX.	UNITS	
V_{RRM}		40	V	
I _{F(AV)}	Rectangular waveform	1.5	Λ	
I _{FSM}		250	^	
V _F	1.5 Apk, T _J = 125 °C	0.47	V	
T _J		- 55 to 150	°C	

VOLTAGE RATINGS				
PARAMETER	SYMBOL	FCSP2H40LTR	UNITS	
Maximum DC reverse voltage	V _R	40	V	
Maximum working peak reverse voltage	V_{RWM}	40	V	

FCSP2H40LTR

Vishay High Power Products

FlipKY®, 1.5 A Chip Scale Package Schottky Barrier Rectifier



ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum average forward current	I _{F(AV)}	50 % duty cycle at T _{PCB} = 102 °C, rectangular waveform		1.5	
Maximum peak one cycle non-repetitive surge current at 25 °C		5 μs sine or 3 μs rect. pulse	Following any rated load condition and with rated V _{RRM} applied	250	Α
	I _{FSM}	10 ms sine or 6 ms rect. pulse		21	
Non-repetitive avalanche energy	E _{AS}	$T_J = 25 ^{\circ}\text{C}$, $I_{AS} = 2.0 \text{A}$, $L = 5.0 \text{mH}$		10	mJ
Repetitive avalanche current	I _{AR}	Current decaying linearly to zero in 1 μ s Frequency limited by T _J maximum V _A = 1.5 x V _B typical		2.0	Α

ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS		TYP.	MAX.	UNITS
Maximum forward voltage drop	V (1)	1.5 A	T _{.1} = 25 °C	0.52	0.56	V
		3 A	11 = 25 0	0.60	0.65	
See fig. 1	V _{FM} ⁽¹⁾	1.5 A	T _{.1} = 125 °C	0.42	0.47	
		3 A	1j = 125 C	0.54	0.59	
	I _{RM} ⁽¹⁾	T _J = 25 °C	V_R = Rated V_R	3	15	μA mA
			V _R = 20 V	0.5	1	
			V _R = 10 V	0.2	0.5	
Maximum reverse leakage current			V _R = 5 V	0.15	0.3	
See fig. 2		T _J = 125 °C	V _R = Rated V _R	2.5	4	
			V _R = 20 V	0.9	2	
			V _R = 10 V	0.6	1.5	
			V _R = 5 V	0.5	1	
Maximum junction capacitance	C _T	V _R = 5 V _{DC} (test signal range 100 kHz to 1 MHz) 25 °C		-	160	pF
Maximum voltage rate of charge	dV/dt	Rated V _R - 10		10 000	V/µs	

 $^{^{(1)}\,}$ Pulse width < 300 $\mu s,$ duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum junction and storage temperature range	T _J ⁽¹⁾ , T _{Stg}		- 55 to 150	°C
Typical thermal resistance, junction to PCB	R _{thJL} (2)	DC operation	40	°C/W
Maximum thermal resistance, junction to ambient	R _{thJA}		62	C/VV

Notes

 $\frac{\text{dP}_{tot}}{\text{dT}_J} < \frac{1}{R_{thJA}} \quad \text{thermal runaway condition for a diode on its own heatsink}$

(2) Mounted 1" square PCB

Document Number: 94496 Revision: 27-Mar-08



FlipKY®, 1.5 A Chip Scale Package Schottky Barrier Rectifier

Vishay High Power Products

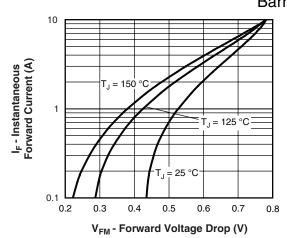


Fig. 1 - Maximum Forward Voltage Drop Characteristics (Per Leg)

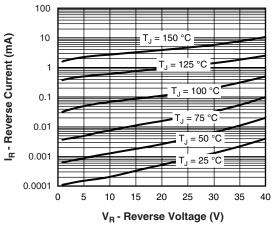


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage (Per Leg)

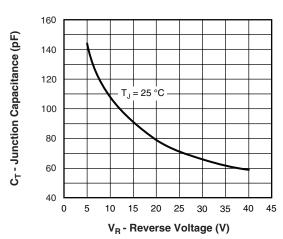


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

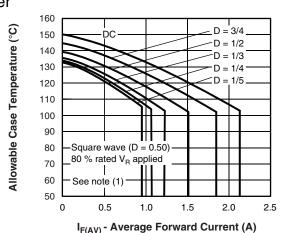


Fig. 4 - Maximum Allowable Case Temperature vs. Average Forward Current (Per Leg)

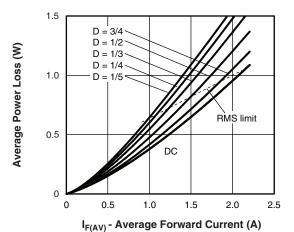


Fig. 5 - Forward Power Loss Characteristics (Per Leg)

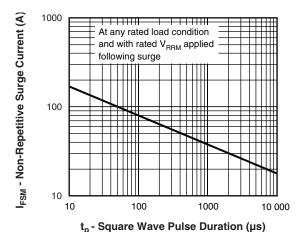


Fig. 6 - Maximum Non-Repetitive Surge Current (Per Leg)

Note

(1) Formula used: $T_C = T_J - (Pd + Pd_{REV}) \times R_{th,JC}$; $Pd = Forward power loss = I_{F(AV)} \times V_{FM}$ at $(I_{F(AV)}/D)$ (see fig. 6); $Pd_{REV} = Inverse$ power loss = $V_{R1} \times I_{R}$ (1 - D); I_{R} at 80 % V_{R} applied

FCSP2H40LTR

Vishay High Power Products

FlipKY[®], 1.5 A Chip Scale Package Schottky Barrier Rectifier



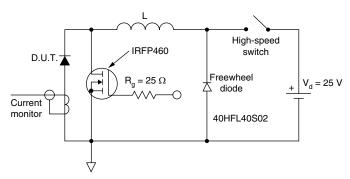


Fig. 7 - Unclamped Inductive Test Circuit

LINKS TO RELATED DOCUMENTS			
Dimensions http://www.vishay.com/doc?95282			
Part marking information	http://www.vishay.com/doc?95281		
Packaging information	http://www.vishay.com/doc?95062		

Document Number: 94496 Revision: 27-Mar-08



Vishay

Disclaimer

All product specifications and data are subject to change without notice.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained herein or in any other disclosure relating to any product.

Vishay disclaims any and all liability arising out of the use or application of any product described herein or of any information provided herein to the maximum extent permitted by law. The product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein, which apply to these products.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications unless otherwise expressly indicated. Customers using or selling Vishay products not expressly indicated for use in such applications do so entirely at their own risk and agree to fully indemnify Vishay for any damages arising or resulting from such use or sale. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

Product names and markings noted herein may be trademarks of their respective owners.

Revision: 18-Jul-08

Document Number: 91000 www.vishay.com